

FEATURES

- 25, 45 ns Read Access & R/W Cycle Time
- Unlimited Read/Write Endurance
- Pin compatible with industry standard SRAMs
- Automatic Non-volatile STORE on Power Loss
- Automatic RECALL to SRAM on Power Up
- Non-Volatile STORE or RECALL under Software Control
- Unlimited RECALL Cycles
- 1 Million Store Cycles
- 100-Year Non-volatile Data Retention
- Single 5V \pm 10% Power Supply
- Commercial and Industrial Temperatures
- 28-pin 300-mil and 330 mil SOIC Packages (RoHS-Compliant)

DESCRIPTION

The Simtek STK15C88 is a 256Kb fast static RAM with a non-volatile Quantum Trap storage element included with each memory cell.

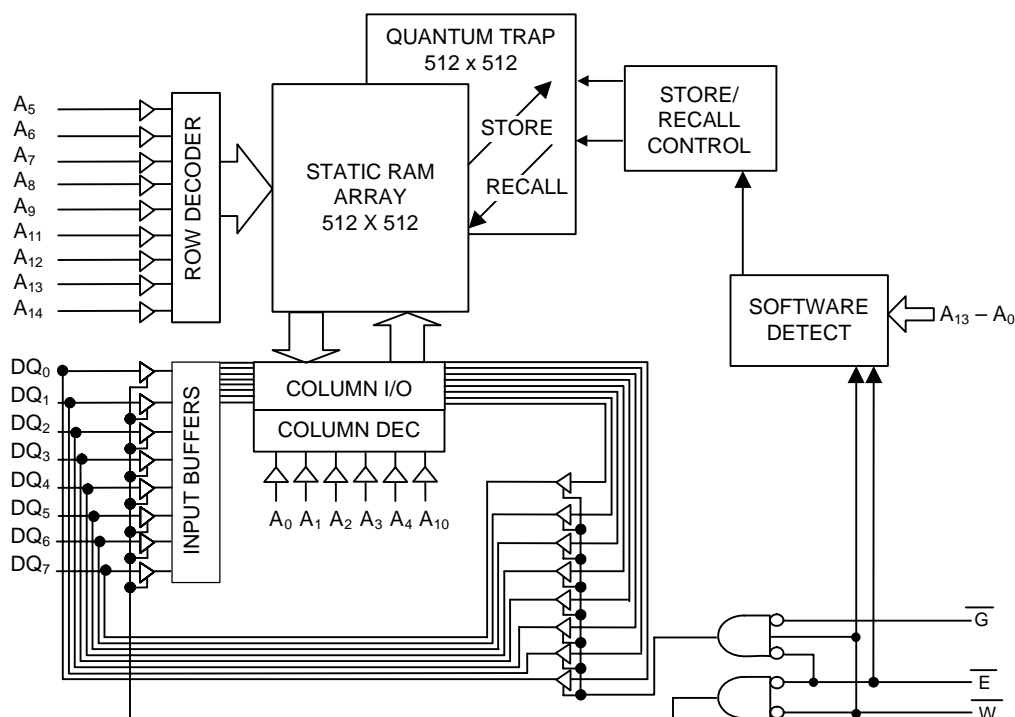
The SRAM provides the fast access & cycle times, ease of use and unlimited read & write endurance of a normal SRAM.

Data transfers automatically to the non-volatile storage cells when power loss is detected (the *STORE* operation). On power up, data is automatically restored to the SRAM (the *RECALL* operation). Both *STORE* and *RECALL* operations are also available under software control.

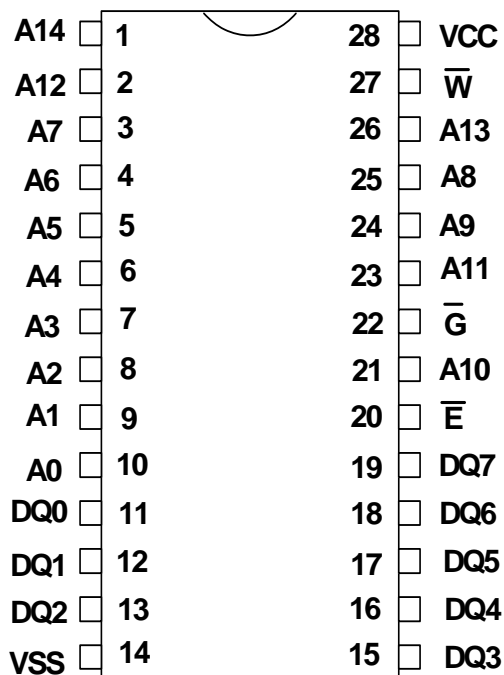
PowerStore nvSRAM products depend on the intrinsic system capacitance to maintain system power long enough for an automatic store on power loss. If the power ramp from 5 volts to 3.6 volts is faster than 10 ms, consider our 14C88 or 16C88 for more reliable operation.

The Simtek nvSRAM is the first monolithic non-volatile memory to offer unlimited writes and reads. It is the highest performance, most reliable non-volatile memory available.

BLOCK DIAGRAM



PIN CONFIGURATIONS



28 Pin 300 mil SOIC

28 Pin 330 mil SOIC

PIN NAMES

Pin Name	I/O	Description
A ₁₄ -A ₀	Input	Address: The 15 address inputs select one of 32,768 bytes in the nvSRAM array
DQ ₇ -DQ ₀	I/O	Data: Bi-directional 8-bit data bus for accessing the nvSRAM
\bar{E}	Input	Chip Enable: The active low \bar{E} input selects the device
\bar{W}	Input	Write Enable: The active low \bar{W} enables data on the DQ pins to be written to the address location latched by the falling edge of \bar{E}
\bar{G}	Input	Output Enable: The active low \bar{G} input enables the data output buffers during read cycles. De-asserting \bar{G} high caused the DQ pins to tri-state.
V _{CC}	Power Supply	Power: 5.0V, ±10%
V _{SS}	Power Supply	Ground

ABSOLUTE MAXIMUM RATINGS^a

Voltage on Input Relative to Ground -0.5V to 7.0V
 Voltage on Input Relative to V_{SS} -0.6V to (V_{CC} + 0.5V)
 Voltage on DQ₀₋₇ -0.5V to (V_{CC} + 0.5V)
 Temperature under Bias -55°C to 125°C
 Storage Temperature -65°C to 150°C
 Power Dissipation 1W
 DC Output Current (1 output at a time, 1s duration) 15mA

Note a: Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC CHARACTERISTICS

(V_{CC} = 5.0V ± 10%)

SYMBOL	PARAMETER	COMMERCIAL		INDUSTRIAL		UNITS	NOTES
		MIN	MAX	MIN	MAX		
I _{CC1} ^b	Average V _{CC} Current		97 70		100 70	mA mA	t _{AVAV} = 25ns t _{AVAV} = 45ns
I _{CC2} ^c	Average V _{CC} Current during STORE		3		3	mA	All Inputs Don't Care, V _{CC} = max
I _{CC3} ^b	Average V _{CC} Current at t _{AVAV} = 200ns (Standby, 5V, 25°C, Typical)		10		10	mA	$\bar{V} \geq (V_{CC} - 0.2V)$ All Others Cycling, CMOS Levels
I _{CC4} ^c	Average V _{CAP} Current during AutoStore Cycle		2		2	mA	All Inputs Don't Care
I _{SB1} ^d	Average V _{CC} Current (Standby, Cycling TTL Input Levels)		30 22		31 23	mA mA	t _{AVAV} = 25ns, $\bar{E} \geq V_{IH}$ t _{AVAV} = 45ns, $\bar{E} \geq V_{IH}$
I _{SB2} ^d	V _{CC} Standby Current (Standby, Stable CMOS Input Levels)		1.5		1.5	mA	$\bar{E} \geq (V_{CC} - 0.2V)$ All Others V _{IN} ≤ 0.2V or ≥ (V _{CC} - 0.2V)
I _{ILK}	Input Leakage Current		±1		±1	µA	V _{CC} = max V _{IN} = V _{SS} to V _{CC}
I _{OLK}	Off-State Output Leakage Current		±5		±5	µA	V _{CC} = max V _{IN} = V _{SS} to V _{CC} , \bar{E} or $\bar{G} \geq V_{IH}$
V _{IH}	Input Logic “1” Voltage	2.2	V _{CC} + .5	2.2	V _{CC} + .5	V	All Inputs
V _{IL}	Input Logic “0” Voltage	V _{SS} - .5	0.8	V _{SS} - .5	0.8	V	All Inputs
V _{OH}	Output Logic “1” Voltage	2.4		2.4		V	I _{OUT} = -4mA
V _{OL}	Output Logic “0” Voltage		0.4		0.4	V	I _{OUT} = 8mA
T _A	Operating Temperature	0	70	-40	85	°C	

Note b: I_{CC1} and I_{CC3} are dependent on output loading and cycle rate. The specified values are obtained with outputs unloaded.

Note c: I_{CC2} and I_{CC4} are the average currents required for the duration of the respective STORE cycles (t_{STORE}).

Note d: $\bar{E} \geq V_{IH}$ will not produce standby current levels until any nonvolatile cycle in progress has timed out.

AC TEST CONDITIONS

Input Pulse Levels	0V to 3V
Input Rise and Fall Times	≤ 5ns
Input and Output Timing Reference Levels	1.5V
Output Load	See Figure 1

CAPACITANCE^e (T_A = 25°C, f = 1.0MHz)

SYMBOL	PARAMETER	MAX	UNITS	CONDITIONS
C _{IN}	Input Capacitance	5	pF	ΔV = 0 to 3V
C _{OUT}	Output Capacitance	7	pF	ΔV = 0 to 3V

Note e: These parameters are guaranteed but not tested.

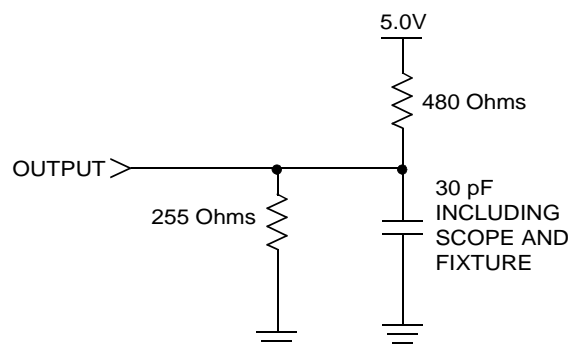


Figure 1: AC Output Loading

SRAM READ CYCLES #1 & #2 ($V_{CC} = 5.0V \pm 10\%$)

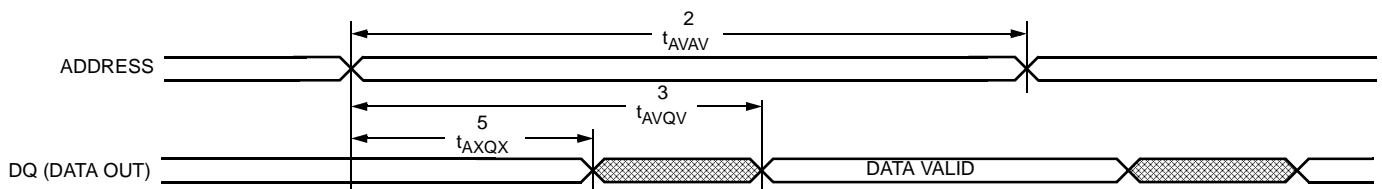
NO.	SYMBOLS		PARAMETER	STK15C88-25		STK15C88-45		UNITS
	#1, #2	Alt.		MIN	MAX	MIN	MAX	
1	t_{ELQV}	t_{ACS}	Chip Enable Access Time		25		45	ns
2	t_{AVAV}^f	t_{RC}	Read Cycle Time	25		45		ns
3	t_{AVQV}^g	t_{AA}	Address Access Time		25		45	ns
4	t_{GLQV}	t_{OE}	Output Enable to Data Valid		10		20	ns
5	t_{AXQX}^g	t_{OH}	Output Hold after Address Change	5		5		ns
6	t_{ELQX}	t_{LZ}	Chip Enable to Output Active	5		5		ns
7	t_{EHQZ}^h	t_{HZ}	Chip Disable to Output Inactive		10		15	ns
8	t_{GLQX}	t_{OLZ}	Output Enable to Output Active	0		0		ns
9	t_{GHQZ}^h	t_{OHZ}	Output Disable to Output Inactive		10		15	ns
10	t_{ELICCH}^e	t_{PA}	Chip Enable to Power Active	0		0		ns
11	$t_{EHICCL}^{d, e}$	t_{PS}	Chip Disable to Power Standby		25		45	ns

Note f: \bar{W} must be high during SRAM READ cycles and low during SRAM WRITE cycles.

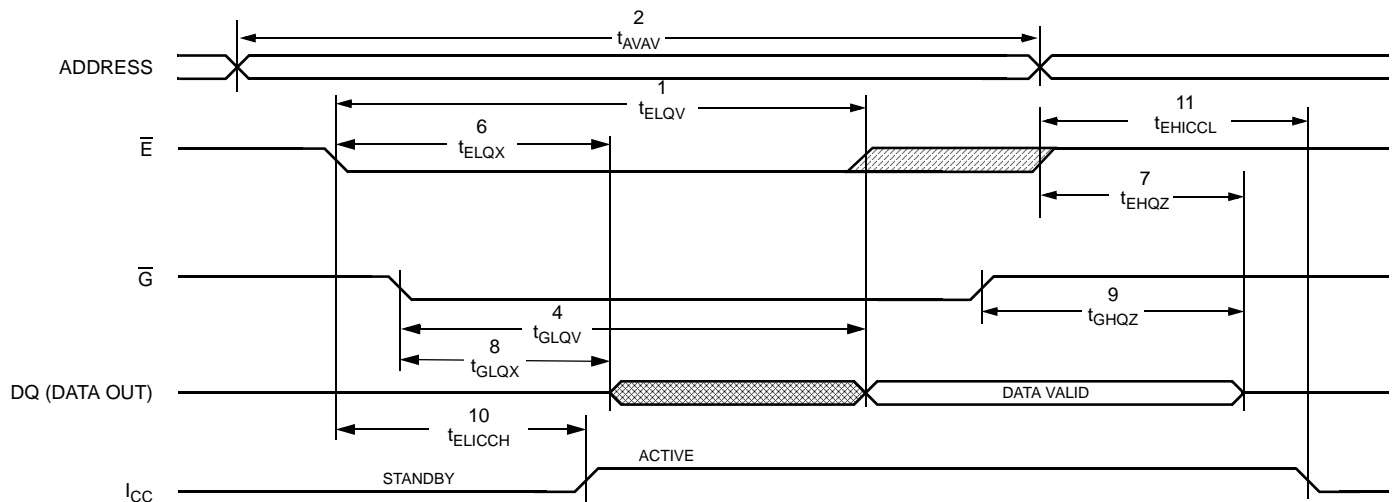
Note g: I/O state assumes $\bar{E}, \bar{G} \leq V_{IL}$ and $\bar{W} \geq V_{IH}$; device is continuously selected.

Note h: Measured $\pm 200mV$ from steady state output voltage.

SRAM READ CYCLE #1: Address Controlled^{f, g}



SRAM READ CYCLE #2: \bar{E} Controlled^f



SRAM WRITE CYCLES #1 & #2

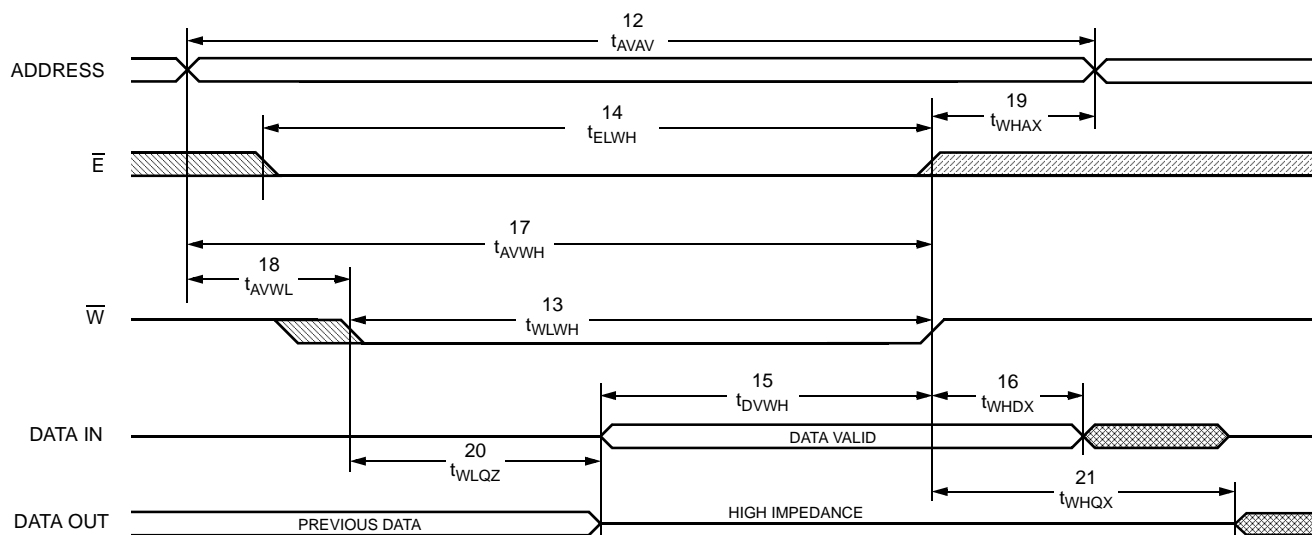
(V_{CC} = 5.0V ± 10%)

NO.	SYMBOLS			PARAMETER	STK15C88-25		STK15C88-45		UNITS
	#1	#2	Alt.		MIN	MAX	MIN	MAX	
12	t _{AVAV}	t _{AVAV}	t _{WC}	Write Cycle Time	25		45		ns
13	t _{WLWH}	t _{WLEH}	t _{WP}	Write Pulse Width	20		30		ns
14	t _{ELWH}	t _{ELEH}	t _{CW}	Chip Enable to End of Write	20		30		ns
15	t _{DVWH}	t _{DVEH}	t _{DW}	Data Set-up to End of Write	10		15		ns
16	t _{WHDX}	t _{EHDX}	t _{DH}	Data Hold after End of Write	0		0		ns
17	t _{AVWH}	t _{AVEH}	t _{AW}	Address Set-up to End of Write	20		30		ns
18	t _{AVWL}	t _{AVEL}	t _{AS}	Address Set-up to Start of Write	0		0		ns
19	t _{WHAX}	t _{EHAX}	t _{WR}	Address Hold after End of Write	0		0		ns
20	t _{WLQZ^{h,i}}		t _{WZ}	Write Enable to Output Disable		10		15	ns
21	t _{WHQX}		t _{OW}	Output Active after End of Write	5		5		ns

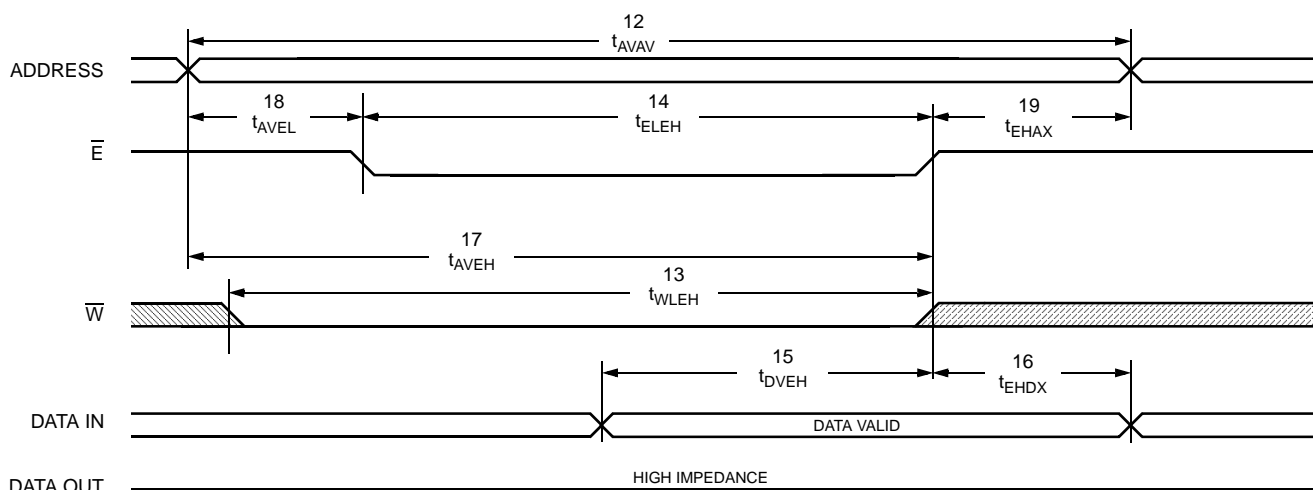
Note i: If \bar{W} is low when \bar{E} goes low, the outputs remain in the high-impedance state.

Note j: \bar{E} or \bar{W} must be $\geq V_{IH}$ during address transitions.

SRAM WRITE CYCLE #1: \bar{W} Controlled^j



SRAM WRITE CYCLE #2: \bar{E} Controlled^j



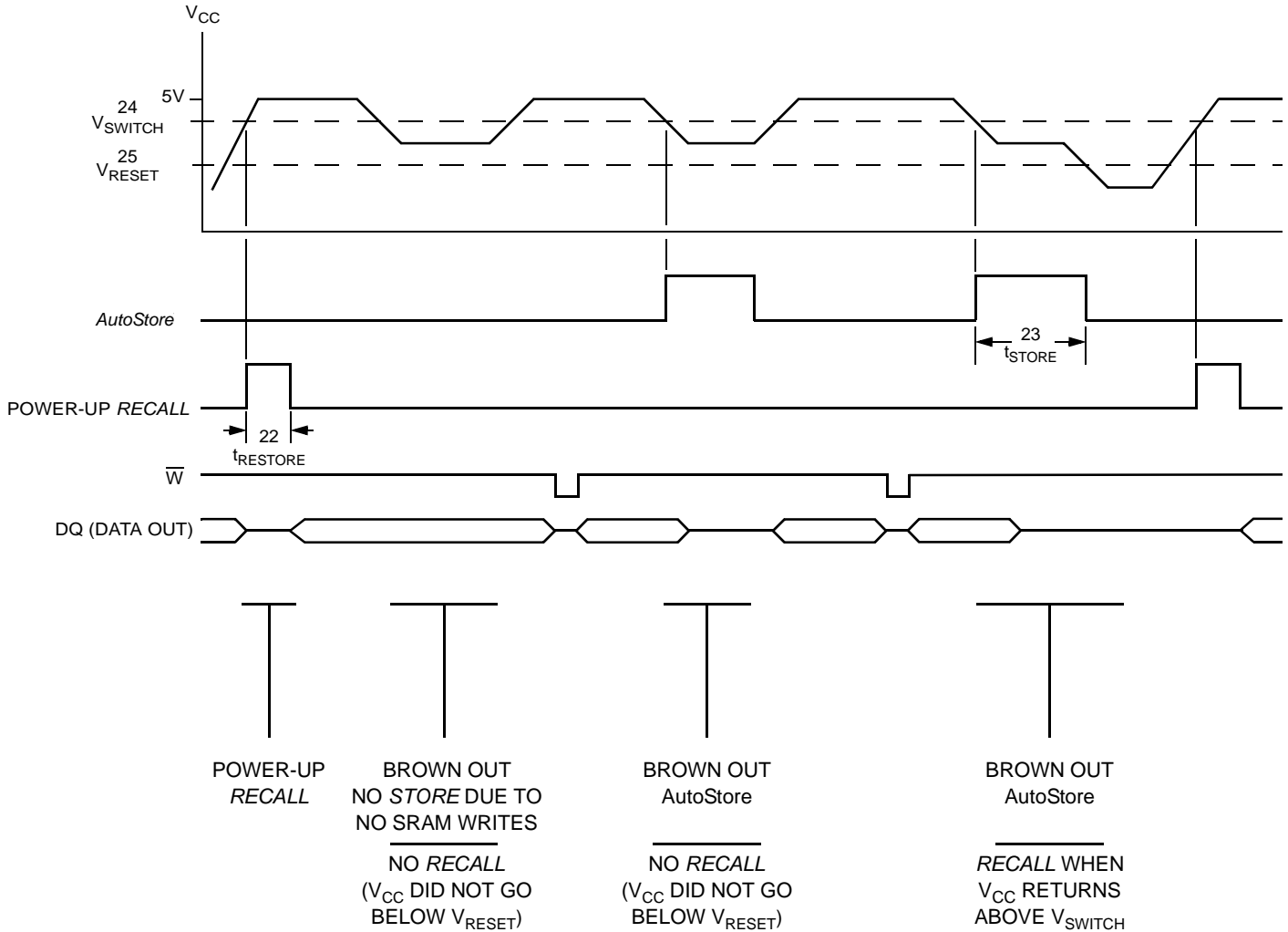
AutoStore/POWER-UP RECALL

($V_{CC} = 5.0V \pm 10\%$)

NO.	SYMBOLS	PARAMETER	STK15C88		UNITS	NOTES
	Standard		MIN	MAX		
22	$t_{RESTORE}$	Power-up <i>RECALL</i> Duration		550	μs	k
23	t_{STORE}	<i>STORE</i> Cycle Duration		10	ms	g
24	V_{SWITCH}	Low Voltage Trigger Level	4.0	4.5	V	
25	V_{RESET}	Low Voltage Reset Level		3.6	V	

Note k: $t_{RESTORE}$ starts from the time V_{CC} rises above V_{SWITCH} .

AutoStore/POWER-UP RECALL



SOFTWARE STORE/RECALL MODE SELECTION

\bar{E}	\bar{W}	A ₁₃ - A ₀ (hex)	MODE	I/O	NOTES
L	H	0E38	Read SRAM	Output Data	l, m
		31C7	Read SRAM	Output Data	
		03E0	Read SRAM	Output Data	
		3C1F	Read SRAM	Output Data	
		303F	Read SRAM	Output Data	
		0FC0	Nonvolatile STORE	Output High Z	
L	H	0E38	Read SRAM	Output Data	l, m
		31C7	Read SRAM	Output Data	
		03E0	Read SRAM	Output Data	
		3C1F	Read SRAM	Output Data	
		303F	Read SRAM	Output Data	
		0C63	Nonvolatile RECALL	Output High Z	

Note l: The six consecutive addresses must be in the order listed. \bar{W} must be high during all six consecutive cycles to enable a nonvolatile cycle.

Note m: While there are 15 addresses on the STK15C88, only the lower 14 are used to control software modes.

SOFTWARE STORE/RECALL CYCLE^{n, o}

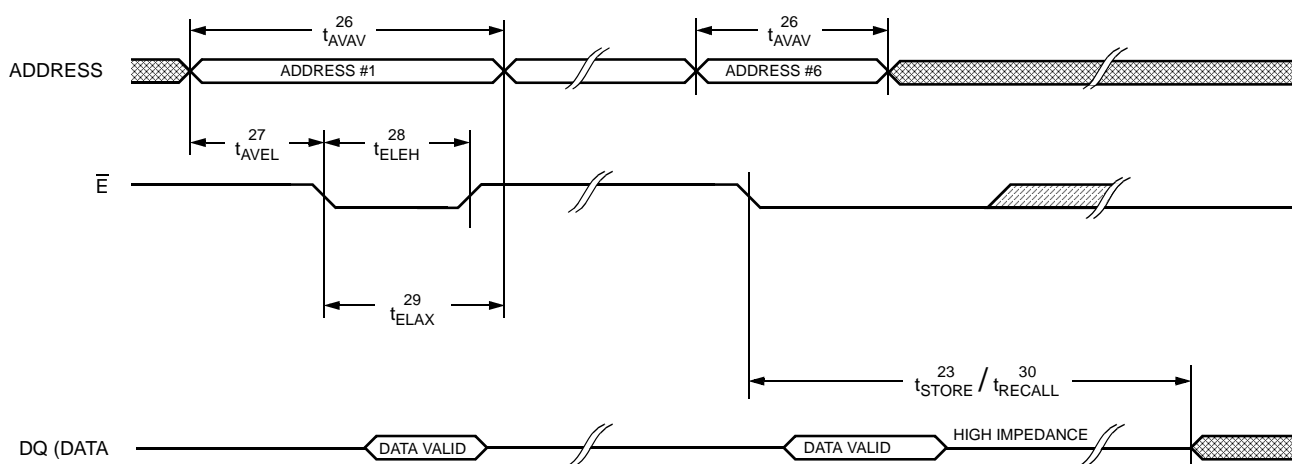
(V_{CC} = 5.0V ± 10%)

NO.	SYMBOLS	PARAMETER	STK15C88-25		STK15C88-45		UNITS
			MIN	MAX	MIN	MAX	
26	t _{AVAV}	STORE/RECALL Initiation Cycle Time	25		45		ns
27	t _{AVEL} ⁿ	Address Set-up Time	0		0		ns
28	t _{ELEH} ⁿ	Clock Pulse Width	20		30		ns
29	t _{ELAX} ^{g, n}	Address Hold Time	20		20		ns
30	t _{RECALL}	RECALL Duration		20		20	μs

Note n: The software sequence is clocked with \bar{E} controlled reads.

Note o: The six consecutive addresses must be in the order listed in the Software STORE/RECALL Mode Selection Table: (0E38, 31C7, 03E0, 3C1F, 303F, 0FC0) for a STORE cycle or (0E38, 31C7, 03E0, 3C1F, 303F, 0C63) for a RECALL cycle. \bar{W} must be high during all six consecutive cycles.

SOFTWARE STORE/RECALL CYCLE: \bar{E} Controlled^o



nvSRAM OPERATION

The STK15C88 is a versatile memory chip that provides several modes of operation. The STK15C88 can operate as a standard 32K x 8 SRAM. It has a 32K x 8 nonvolatile element shadow to which the SRAM information can be copied, or from which the SRAM can be updated in nonvolatile mode.

NOISE CONSIDERATIONS

Note that the STK15C88 is a high-speed memory and so must have a high-frequency bypass capacitor of approximately 0.1µF connected between V_{CC} and V_{SS} , using leads and traces that are as short as possible. As with all high-speed CMOS ICs, normal careful routing of power, ground and signals will help prevent noise problems.

SRAM READ

The STK15C88 performs a READ cycle whenever \bar{E} and \bar{G} are low and \bar{W} is high. The address specified on pins A_{0-14} determines which of the 32,768 data bytes will be accessed. When the READ is initiated by an address transition, the outputs will be valid after a delay of t_{AVQV} (READ cycle #1). If the READ is initiated by \bar{E} or \bar{G} , the outputs will be valid at t_{ELQV} or at t_{GLQV} , whichever is later (READ cycle #2). The data outputs will repeatedly respond to address changes within the t_{AVQV} access time without the need for transitions on any control input pins, and will remain valid until another address change or until \bar{E} or \bar{G} is brought high.

SRAM WRITE

A WRITE cycle is performed whenever \bar{E} and \bar{W} are low. The address inputs must be stable prior to entering the WRITE cycle and must remain stable until either \bar{E} or \bar{W} goes high at the end of the cycle. The data on the common I/O pins DQ_{0-7} will be written into the memory if it is valid t_{DVWH} before the end of a \bar{W} controlled WRITE or t_{DVEH} before the end of an \bar{E} controlled WRITE.

It is recommended that \bar{G} be kept high during the entire WRITE cycle to avoid data bus contention on the common I/O lines. If \bar{G} is left low, internal circuitry will turn off the output buffers t_{WLQZ} after \bar{W} goes low.

SOFTWARE NONVOLATILE STORE

The STK15C88 software STORE cycle is initiated by executing sequential READ cycles from six specific address locations. During the STORE cycle an erase of the previous nonvolatile data is first performed, followed by a program of the nonvolatile elements. The program operation copies the SRAM data into nonvolatile memory. Once a STORE cycle is initiated, further input and output are disabled until the cycle is completed.

Because a sequence of READs from specific addresses is used for STORE initiation, it is important that no other READ or WRITE accesses intervene in the sequence or the sequence will be aborted and no STORE or RECALL will take place.

To initiate the software STORE cycle, the following READ sequence must be performed:

1. Read address	0E38 (hex)	Valid READ
2. Read address	31C7 (hex)	Valid READ
3. Read address	03E0 (hex)	Valid READ
4. Read address	3C1F (hex)	Valid READ
5. Read address	303F (hex)	Valid READ
6. Read address	0FC0 (hex)	Initiate STORE cycle

The software sequence must be clocked with \bar{E} controlled READS.

Once the sixth address in the sequence has been entered, the STORE cycle will commence and the chip will be disabled. It is important that READ cycles and not WRITE cycles be used in the sequence, although it is not necessary that \bar{G} be low for the sequence to be valid. After the t_{STORE} cycle time has been fulfilled, the SRAM will again be activated for READ and WRITE operation.

SOFTWARE NONVOLATILE RECALL

A software RECALL cycle is initiated with a sequence of READ operations in a manner similar to the software STORE initiation. To initiate the RECALL cycle, the following sequence of READ operations must be performed:

1. Read address	0E38 (hex)	Valid READ
2. Read address	31C7 (hex)	Valid READ
3. Read address	03E0 (hex)	Valid READ
4. Read address	3C1F (hex)	Valid READ
5. Read address	303F (hex)	Valid READ
6. Read address	0C63 (hex)	Initiate RECALL cycle

Internally, *RECALL* is a two-step procedure. First, the SRAM data is cleared, and second, the nonvolatile information is transferred into the SRAM cells. After the t_{RECALL} cycle time the SRAM will once again be ready for READ and WRITE operations. The *RECALL* operation in no way alters the data in the nonvolatile elements. The nonvolatile data can be recalled an unlimited number of times.

AutoStore™ OPERATION

The STK15C88 uses the intrinsic system capacitance to perform an automatic *STORE* on power down. As long as the system power supply takes at least t_{STORE} to decay from V_{SWITCH} down to 3.6V, the STK15C88 will safely and automatically store the SRAM data in nonvolatile elements on power down.

In order to prevent unneeded *STORE* operations, automatic *STOREs* will be ignored unless at least one *WRITE* operation has taken place since the most recent *STORE* or *RECALL* cycle. Software-initiated *STORE* cycles are performed regardless of whether a *WRITE* operation has taken place. Additional information may be found in applications note “Applying the STK11C88, STK15C88 and STK16C88 32K nvSRAM.”

POWER-UP RECALL

During power up, or after any low-power condition ($V_{CC} < V_{RESET}$), an internal *RECALL* request will be latched. When V_{CC} once again exceeds the sense voltage of V_{SWITCH} , a *RECALL* cycle will automatically be initiated and will take $t_{RESTORE}$ to complete.

If the STK15C88 is in a *WRITE* state at the end of power-up *RECALL*, the SRAM data will be corrupted.

To help avoid this situation, a 10K Ohm resistor should be connected either between \bar{W} and system V_{CC} or between \bar{E} and system V_{CC} .

HARDWARE PROTECT

The STK15C88 offers hardware protection against inadvertent *STORE* operation and SRAM *WRITES* during low-voltage conditions. When $V_{CC} < V_{SWITCH}$, all software *STORE* operations and SRAM *WRITES* are inhibited.

LOW AVERAGE ACTIVE POWER

The STK15C88 draws significantly less current when it is cycled at times longer than 50ns. Figure 2 shows the relationship between I_{CC} and READ cycle time. Worst-case current consumption is shown for both CMOS and TTL input levels (commercial temperature range, $V_{CC} = 5.5V$, 100% duty cycle on chip enable). Figure 3 shows the same relationship for *WRITE* cycles. If the chip enable duty cycle is less than 100%, only standby current is drawn when the chip is disabled. The overall average current drawn by the STK15C88 depends on the following items: 1) CMOS vs. TTL input levels; 2) the duty cycle of chip enable; 3) the overall cycle rate for accesses; 4) the ratio of *READs* to *WRITEs*; 5) the operating temperature; 6) the V_{CC} level; and 7) I/O loading.

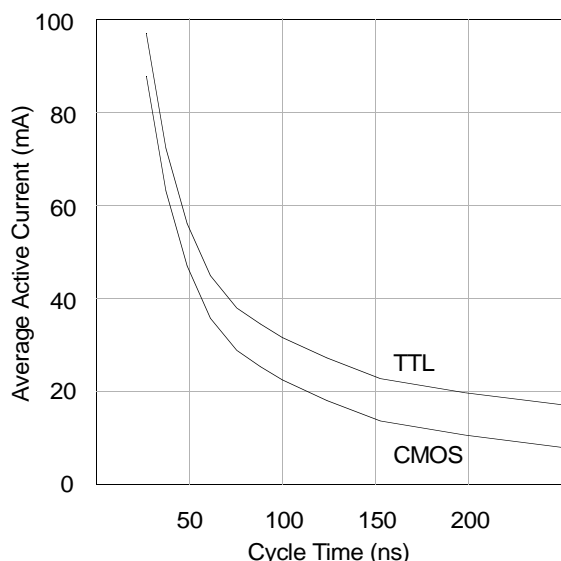


Figure 2: I_{CC} (max) Reads

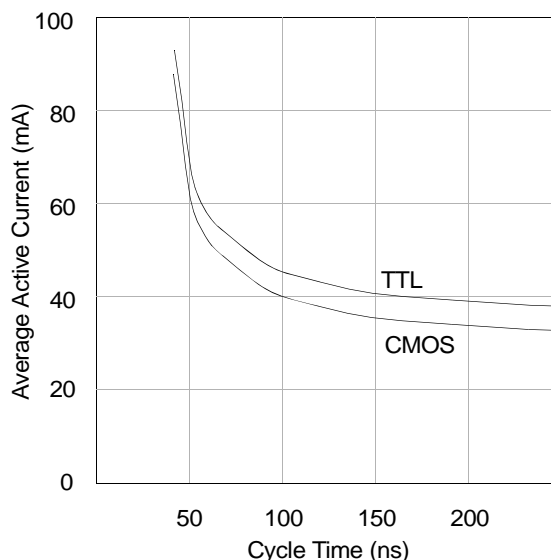
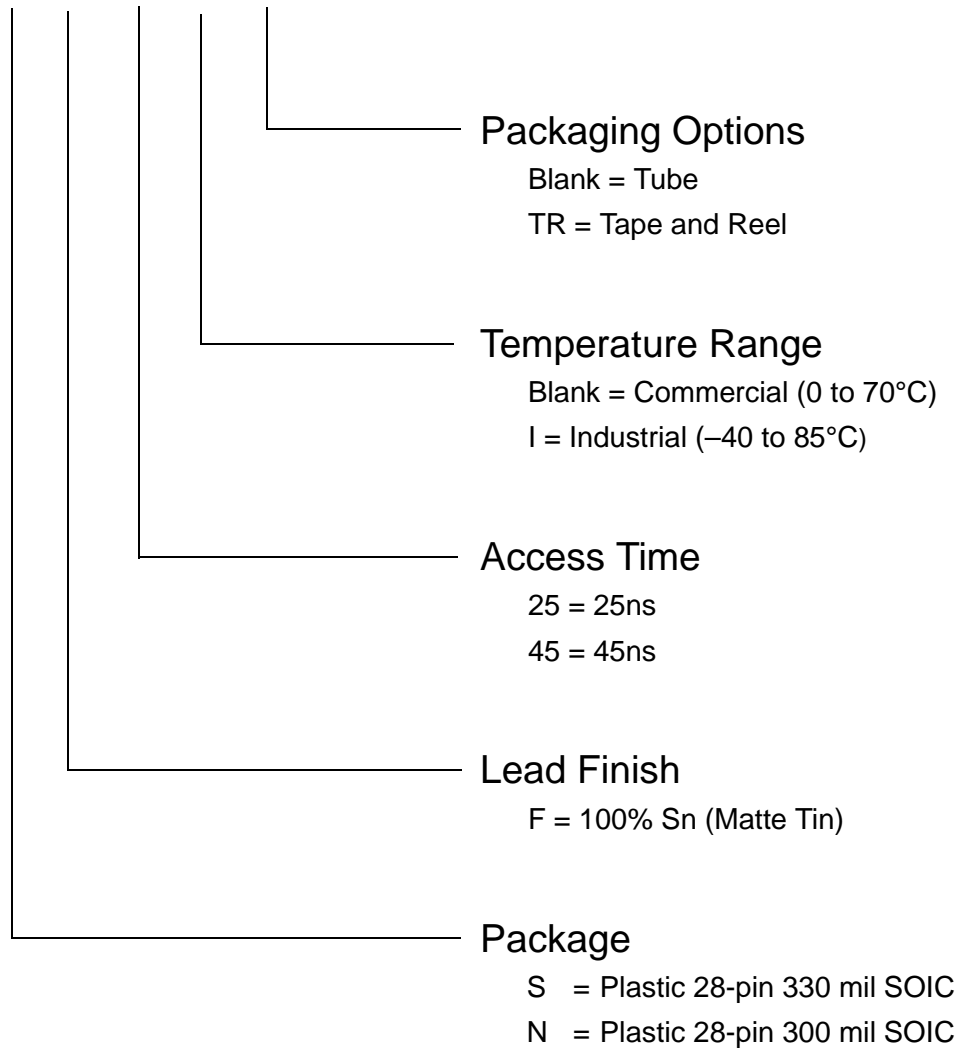


Figure 3: I_{CC} (max) Writes

ORDERING INFORMATION

STK15C88 - N F 45 I TR

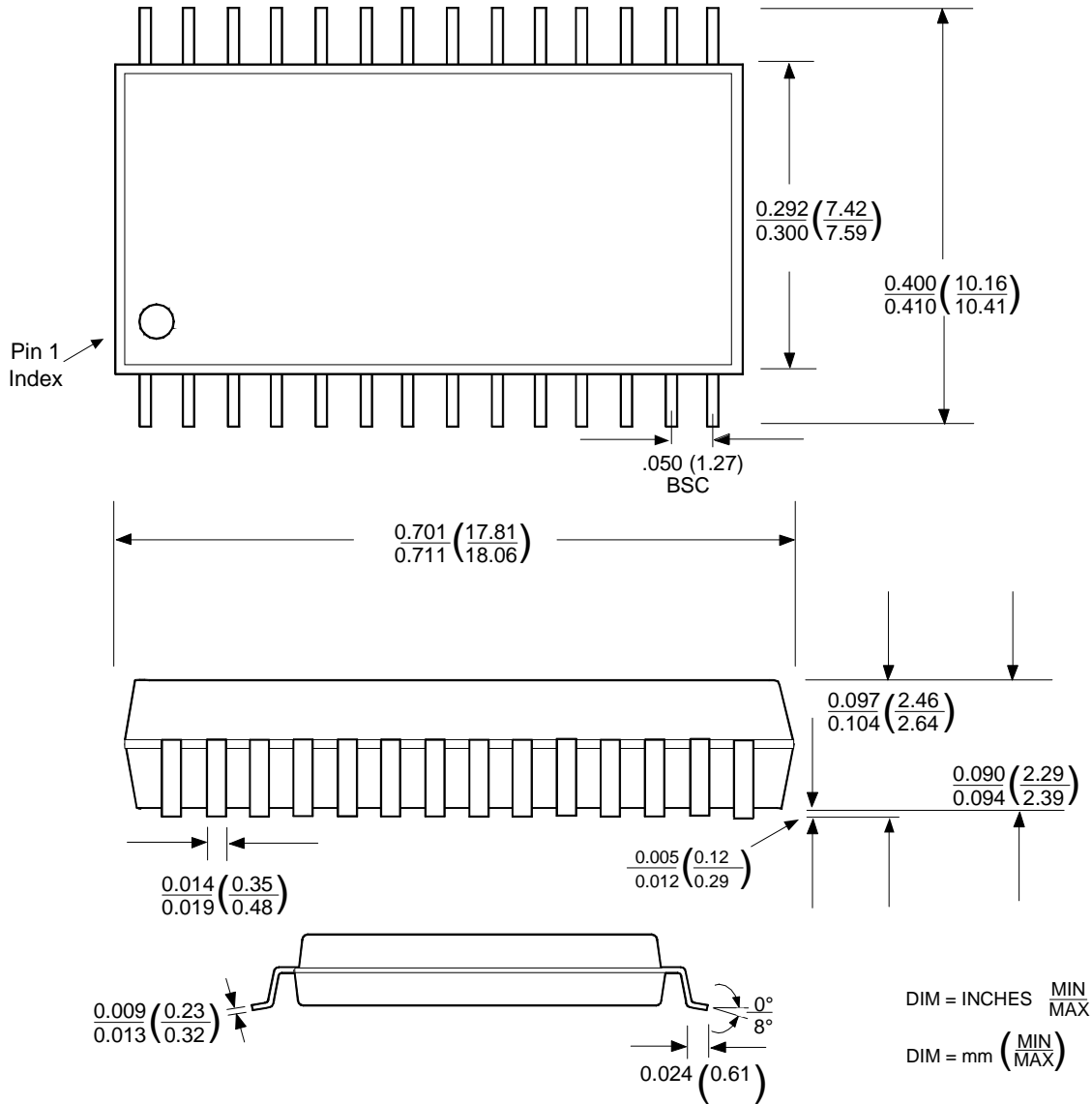


ORDERING CODES

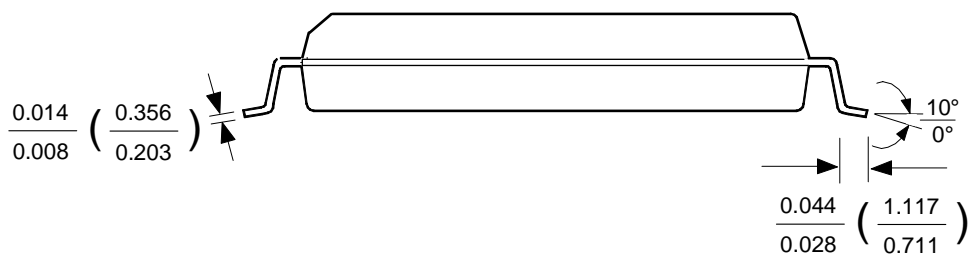
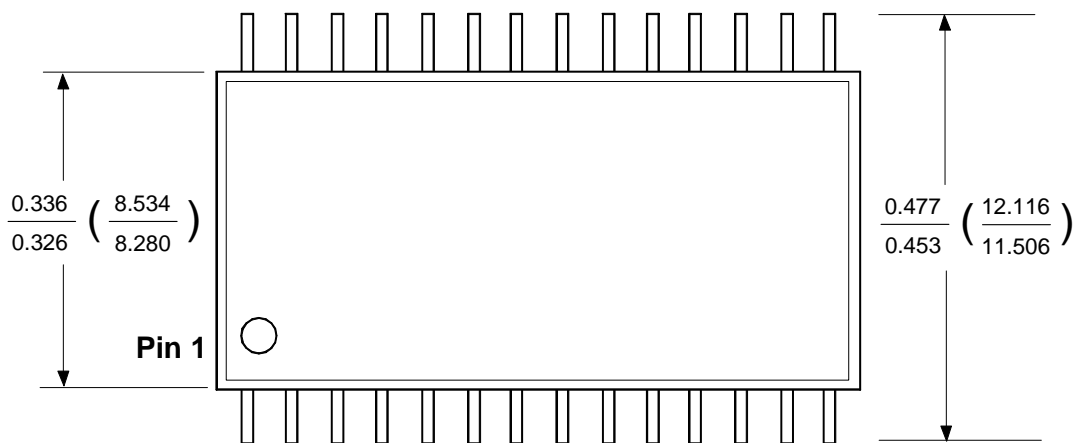
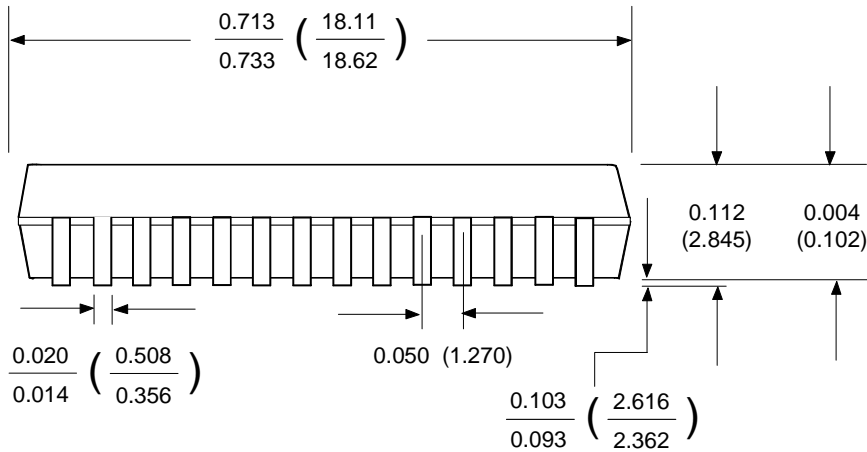
STK15C88-SF25	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Commercial
STK15C88-SF45	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Commercial
STK15C88-NF25	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Commercial
STK15C88-NF45	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Commercial
STK15C88-SF25TR	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Commercial
STK15C88-SF45TR	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Commercial
STK15C88-NF25TR	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Commercial
STK15C88-NF45TR	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Commercial
STK15C88-SF25I	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Industrial
STK15C88-SF45I	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Industrial
STK15C88-NF25I	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Industrial
STK15C88-NF45I	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Industrial
STK15C88-SF25ITR	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Industrial
STK15C88-SF45ITR	5V 32Kx8 PowerStore nvSRAM	SOP28-330	Industrial
STK15C88-NF25ITR	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Industrial
STK15C88-NF45ITR	5V 32Kx8 PowerStore nvSRAM	SOP28-300	Industrial

PACKAGE DRAWINGS

28 Pin 300 mil SOIC



28 Pin 330 mil SOIC



DIM = INCHES $\frac{\text{MIN}}{\text{MAX}}$

DIM = mm ($\frac{\text{MIN}}{\text{MAX}}$)

Document Revision History

Revision	Date	Summary
0.0	December 2002	
0.1	September 2003	Added lead-free lead finish
0.2	March 2006	Removed DIP packages, Removed 35ns Speed Grade, Remove leaded lead finish
0.3	February 2007	Add fast power-down slew rate information Add Tape Reel Ordering Options Add Product Ordering Code Listing Add Package Drawings Reformat Entire Document

SIMTEK STK15C88 Datasheet, February 2007

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